Design and initial characterisation of x-ray beam diagnostic imagers for the European XFEL

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ABSTRACT
The European X-Ray Free-Electron-Laser facility requires diagnostics of its x-ray photon beam. Besides other diagnostic components, imaging stations will be employed for the characterisation of beam properties like position, profile, and pointing, before and after different types of mirrors, slits and monochromators. In combination with soft x-ray grating monochromators or other dispersive devices, imagers can also deliver spectral information. The imagers will usually absorb the beam (invasive devices), however, for some applications they will be partially transmissive to allow for beam pointing monitoring together with a second imaging unit further downstream. For the first commissioning 25 diagnostic imagers are planned at various positions in the photon beam tunnels. Further similar devices are under development for monitoring the beam properties at the experimental stations.

The design of these imaging stations will be described. Initial testing has started and the optimization of some components will be reported. The main components of these imaging stations are: retractive scintillators for conversion of x-rays to visible light, mirrors, optics and CCD / CMOS cameras for image recording, an ultra-high vacuum (UHV) chamber, and the associated control electronics and software. Scintillators and mirrors will be the only components in an ultra-high vacuum chamber. Performance characteristics are addressed, especially mechanical stability, spatial resolution, signal-to-noise properties, and radiation hardness. The challenge in the design is to deal with a wide range of beam properties: photon energies from 0.26 – 25 keV, beam sizes from several 100 μm to several mm, large beam position shifts of up to 120 mm, pulse durations of 10 fs and pulse energies up to 10 mJ which may destroy materials by a single pulse.

Keywords: x-ray beam diagnostics, FEL beam diagnostics, x-ray detection, free-electron-laser instrumentation

1. INTRODUCTION
X-ray Free-Electron-Lasers (XFEL) create radiation by the Self-Amplified Spontaneous Emission (SASE) process when electron bunches pass through very long segmented undulators (periodic magnet structures). The shot noise at the origin of this process leads to significant pulse-to-pulse variations of pulse intensity, spectrum, wavefront, and temporal properties so that an online monitoring of these properties is mandatory. Beam transport mirrors and monochromators steer the FEL beam and therefore require beam position monitors for adjustment. Tuning the long segmented undulators requires dedicated diagnostics such as an undulator commissioning spectrometer and spontaneous radiation analysis.1,2,3

The European XFEL facility started the installation of photon transport devices in 2014. Beginning 2015, the focus is on the installation of components in the XTD2 tunnel, see Figure 1. Amongst various devices in XTD2 and XTD9, diagnostic devices for imaging of the x-ray photon beam are highlighted in orange in Figure 1b.

For the first commissioning 25 diagnostic imaging stations are planned at various positions in the photon beam tunnels of the European XFEL facility. Different types of diagnostic imagers will be employed:

- Transmissive imager (3 devices): for initial beam characterisation close to the undulator upstream of any optics, and for beam pointing together with the FEL imager, see below. This device employs a partially transmissive scintillator.
- Spontaneous Radiation (SR) imager (3 devices): for the visualisation of spontaneous radiation behind the K-monochromator for undulator commissioning and characterisation.
- Free-Electron-Laser (FEL) radiation imager (3 devices): for the alignment of the FEL beam upstream of all mirrors, for controlling and optimisation during operation of shape and position.
- Pop-In monitors (4 different types, 14 devices): for position monitoring downstream of the x-ray optics in order to allow for adjustments of the beam.
- Exit-Slit imager (2 devices): for recording single pulse FEL spectra at the exit slit of the SASE3 monochromator.

Further similar devices are under development by other groups for monitoring the beam properties at the experimental stations.

Figure 1. Installation of photon beam diagnostics at the European XFEL facility.
(a) Photon and electron beam transport.
(b) Diagnostic devices for the SASE1 branch. Diagnostic imagers are highlighted in orange.

2. DESIGN OF DIAGNOSTIC IMAGERS

2.1 Imager concept

The FEL operation can provide x-ray pulses of 100 fs length or shorter at 4.5 MHz, grouped in pulse trains of 2700 pulses and 600 µs duration, repeated at 10 Hz. Photon energies vary between 0.26 to 25 keV. The FEL operation mode provides sufficient intensity per x-ray pulse for a typical scintillation screen – optics – camera system with the advantage of using standard commercial components for optics and camera outside vacuum. Components need to be robust since the installations in the XFEL photon tunnels are not easily accessible. A low noise, low signal design is only required in the case of the SR imager, chapter 2.3. Dynamic range is controlled via the iris of the lenses, neutral density filters or the electronic gain of the camera. Some designs use an optical mirror in the x-ray beam behind the scintillator inclined to 45° to the x-ray beam axis for optimized spatial resolution. On the other hand, mirrors and the damage to them can be avoided by inclining the scintillator w.r.t. the x-ray beam by 45°. Different types of scintillators are used: mainly YAG:Ce (cerium doped Yttrium aluminum garnet, Y₃Al₅O₁₂) and CVD diamond screens for their radiation hardness. Diamond additionally has the advantage of a low atomic number (low-Z) i.e. low x-ray absorption. Their choice is
discussed in more detail below. For all devices, only the scintillator and sometimes a mirror are movable and can be
retracted from the x-ray beam. The SR imager additionally can be retracted vertically.

The general configuration of the imaging systems is shown in Figure 2 for the example of the Pop-In monitors, chapter
2.5. A typical example of a mechanical 3d model is shown in Figure 5.

Some design considerations of the imaging system are particularly important:

**Signal gain and noise**

The x-ray signal is converted into optical photons, an electronic signal and a digital output in the camera. The signal gain
or sensitivity is given by:

\[
\frac{S_{\text{out}}}{S_{\text{in}}} = \eta_{\text{abs}} \eta_{\text{x/v}} \eta_{\text{coll}} \eta_{\text{v/e}} \eta_{\text{e/lsb}}
\]

where \(S_{\text{in}}\) is the incoming x-ray signal, \(S_{\text{out}}\) the digital signal in the camera, \(\eta_{\text{abs}}\) the x-ray absorption efficiency of the
scintillator, \(\eta_{\text{x/v}}\) the energy conversion efficiency from x-ray to light in the scintillator, \(\eta_{\text{coll}}\) the light collection efficiency
of the optics, \(\eta_{\text{v/e}}\) the quantum efficiency of the camera sensor and \(\eta_{\text{e/lsb}}\) the conversion gain into a digital signal.

At low signal level it is convenient to consider the number of x-ray photons necessary to overcome a constant electronic
noise, i.e. the noise equivalent signal (NES). For example “NES = 3 keV rms” refers to a root mean square noise level
that corresponds to the signal generated by one single absorbed photon of 3 keV energy.

**Light collection efficiency**

Amongst the parameters for the signal gain, the light collection efficiency can vary considerably with the kind of
scintillator screen. The collection of light by an optical system from a scintillator is given by:

\[
\eta_{\text{coll,cryst}} = \frac{1}{4} \left( \frac{M}{n 2 f\#} \right)^2, \text{ for an optically polished transparent screen}
\]

\[
\eta_{\text{coll,scat}} = \frac{1}{2} \left( \frac{M}{2 f\#} \right)^2, \text{ for an optically scattering screen, Lambertian emitter}
\]

where \(M\) is the optical magnification, \(n\) the refractive index of the screen, \(f\#\) the f-number of the optics w.r.t. infinity.
These formulas reflect the difficulty to couple light out of a transparent screen towards the optics; total internal
reflections guide the light towards the borders of the screen. For example, for YAG:Ce with \(n = 1.82\) the optics would
collect a factor of 7 more signal from a scattering screen than from a transparent screen. However, the scattering screen
has a different behaviour in terms of spatial resolution.

**Spatial resolution**

The spatial resolution of the imaging system depends on: pixel size of the camera, resolution of the optics, type of
scintillation screen, parallax. The spatial resolution (full width half maximum of line response, fwhm) of a scattering
screen is approximately proportional to its thickness. For a transparent screen the resolution depends on its thickness but also on the depth of focus and diffraction of the optics which is not limiting in the configurations considered here. Parallax is important for screens inclined at 45° w.r.t. the x-ray beam.

**Thermal damage**

The destruction of the scintillator, the mirror or coating materials by melting is estimated by calculating the energy deposited in the absorption volume of the x-rays. The specific heat at low temperatures is used which results in a conservative estimation of the damage threshold. It is assumed that no heat dissipation is relevant between pulses during a single pulse train of 600 μs at 4.5 MHz, i.e. the number of pulses within a pulse train add up. The number of pulses until the melting point is reached, is then given by:

\[
N_{\text{max}} = \Delta T_{\text{max}} \frac{2\pi \sigma^2 l_{\text{abs}} \rho c_p}{Q_0}
\]

where \(\Delta T_{\text{max}}\) is the increase from ambient to melting temperature, \(\sigma = \text{fwhm}/2.35\) the beam diameter, \(l_{\text{abs}}\) the x-ray absorption length in the scintillator, \(\rho\) its density, \(c_p\) the specific heat, and \(Q_0\) the pulse energy. As a result of its low atomic number and high melting point diamond is more resistant than YAG:Ce by a factor 2 – 10 for typical photon energies. Other materials that may serve as scintillators for such applications are under study, i.e. thin layers of low-Z materials, radiation hard and vacuum compatible like BN, see chapter 4.2.

**Vignetting by optics**

The SR imager, chapter 2.3 uses a tandem lens system for high aperture and high light collection efficiency. For the choice of the two lenses especially their entrance pupils have to match in size and have to be as close as possible to each other in order to avoid vignetting, see Figure 3.

**Radiation induced degradation**

Apart from avoiding thermal damage by single or multiple pulses, the accumulated dose for standard lens optics and electronics has to be limited. Above 1 kGy first degradation effects may occur. Special attention has to be given to x-ray photons directly absorbed in the optical sensor: a single x-ray photon may saturate one camera pixel.

### 2.2 Transmissive imager

This imager has been originally designed by DESY for electron beam diagnostics and is called OTR-C for that application. It is modified for x-ray diagnostics by exchanging the scintillator against partially transparent YAG:Ce and diamond screens. The scintillators are perpendicular to the x-ray beam; the optical axis is at 45° to scintillator and camera; this is the Scheimpflug principle, thus avoiding a mirror and allowing for a partial transmissive configuration. The Scheimpflug configuration, however, causes image distortions that may be corrected if necessary.

Application: initial beam characterisation close to undulator (see Figure 1) upstream of any optics, and beam pointing together with the FEL imager, see below.

Design: scintillators (YAG:Ce and diamond), optics (Schneider lens \(f = 120\) mm), demagnification 1:2, camera (Basler Aviator avA2300-25gm). The camera sensor uses a special micro lens array adapted to the tilt of the optical axis.

Specifications: field of view 25 mm, 25 μm spatial resolution, 10 Hz operation.

Status: start of assembling and testing phase planned for 5/2015.

### 2.3 Spontaneous radiation (SR) imager

In SR operation mode the x-ray beam intensity is considerably lower than for FEL operation. Taking into account the larger beam if not lasing, the usage of only two or several undulator segments, a factor of 10⁶ lower intensity is expected. The scintillation screen – optics – camera system requires some optimization in terms of sensitivity in signal response:
(1) High aperture commercial tandem optics (Schneider – Leica) with an effective f-number of 0.95, and a scientific cooled low noise sCMOS camera (Photonic Science), see Figure 3. The tandem optics design is relatively flexible w.r.t. to the choice of different magnifications since magnification is given by the ratio of the focal lengths of the two lenses, and a range of different focal lengths is available from each manufacturer. The entrance pupils, however, have to be closely matched to avoid vignetting, see remarks in chapter 2.1.

(2) An efficient scattering ceramic scintillator (Gd₂O₂S:Pr) with Lambertian emission, see Equation (3).

Both measures increase the sensitivity of the imaging system to an NES = 3 keV rms. This is approximately a factor 200 higher than for the other imagers using a standard machine vision optics and YAG:Ce scintillators. The performance could still be increased by using e.g. in-vacuum optics, fiber optics, or direct x-ray Si detection cameras but with the expense of considerable higher costs and risks in terms of reliability.

Application: visualisation of spontaneous radiation behind the K-monochromator for undulator commissioning and characterisation. Simulations of the alignment process is described in Figure 4.

Design: scintillators (YAG:Ce, Gd₂O₂S:Pr), mirror, tandem optics with motorized iris (Leica – Schneider, f/0.95), low noise camera (Photonic Science sCMOS 16 bit, noise 0.92 e⁻ rms).

Specifications: signal-to noise ratio in SR mode SNR = 90 for 10 pulses averaged and 2×2 binning, 30 μm spatial resolution, demagnification 2.2:1, field of view 26.6×15.0 mm², NES = 20 keV ph rms, dynamic range 10⁶ using iris and camera settings, 10 Hz operation.

Status: design finished, procurement of components and testing has started.

Figure 3. Diagnostic SR imager: schematic optical design.
2.4 Free-electron-laser (FEL) radiation imager

A low noise, low signal design is not required for the FEL imager. Available standard commercial components can be used. The dynamic range is more demanding: the iris of the optics allows a manual presetting of a required signal working point; a remotely controlled motorized filter wheel allows further signal tuning. Two different types of scintillators will be available on the scintillator holder: CVD diamond and YAG:Ce screens. Both are known to be radiation hard for such applications, see remarks in chapter 2.1. Other materials that may serve as scintillators for such applications are under study, i.e. thin layers of low-Z materials, radiation hard and vacuum compatible like BN, see chapter 4.2. The design is shown in Figure 5.

Application: alignment of the FEL beam upstream of all mirrors, for controlling and optimisation during operation of shape and position, also beam pointing together with the Transmissive imager.

Design: scintillator (YAG:Ce, diamond), mirror, optics (Kowa machine vision lenses), CMOS camera (5 Mpixels).

Specifications: 10 µm spatial resolution, field of view 22×16 mm², 10 Hz operation for the start, extension to single pulse detection with gated cameras in the future, see chapter 4.3. Position accuracy 2% of beam size and profile determination. Beam size 0.3 – 1.5 mm. Thermal damage may occur for smaller than 10 pulses at low energies and full current even for diamond scintillators.

Status: assembly started.
2.5 Pop-In monitors

The Pop-In monitors are required for the alignment of the x-ray mirrors and monochromators; to verify the beam position. It is essential to cover a wide field of view. Since spatial resolution is less important and the beam deviation is mainly in the horizontal plane, except type II-90, a mirror is avoided which is an advantage concerning radiation damage.

Four different types of monitors have been designed, see Figure 2. The scintillator is composed out of tiles to cover the large field of view, Figure 6:

- Type I for a small field of view of \(40 \times 23 \text{ mm}^2\) (horizontal \(\times\) vertical) at tunnel positions after the monochromators where no beam deflections occur. The scintillator screen is positioned at 45° to the x-ray beam axis which slightly degrades spatial resolution in one orientation. It avoids a mirror in the x-ray beam to reflect the optical image to the camera. Seven devices at SASE 1, 2, 3 are foreseen. Type I holds three screens.

- Type II-45 for a field of view of \(150 \times 23 \text{ mm}^2\) (hor. \(\times\) vert.) to view the beam deflection of the beam after the different beamline mirrors. Again, the scintillators are installed under an angle of 45° w.r.t. the x-ray beam. Five devices at SASE 1, 2, 3 are foreseen. One scintillator screen is mounted.

- Type II-90 for a field of view of \(120 \times 94 \text{ mm}^2\) (hor. \(\times\) vert.) after the monochromator at SASE3. A mirror is used to view the scintillator at normal incidence. One single device is foreseen at SASE3. One scintillator screen is mounted.

- Type III for a wide field of view of \(200 \times 23 \text{ mm}^2\) (hor. \(\times\) vert.) after the second offset mirror at SASE3 to cover a wide deflection range of the beam. The scintillator is at 45° to the x-ray axis. One device at SASE 3 is foreseen, two cameras side by side cover the large field of view. One scintillator is mounted.

Application: beam position monitoring, and adjustment of the beam downstream of the x-ray optics. Especially the alignment of the different mirrors will deviate the beam over large distances.

Design: scintillator (YAG:Ce, diamond), optics (Kowa machine vision lenses), CCD camera (Basler Aviator).

Specifications: 30 - 100 \(\mu\text{m}\) spatial resolution (slightly asymmetric as a result of the tilt of the scintillator), field of view 40 - 200 mm, 10 Hz operation, position accuracy 2% of beam size. The risk of thermal damage by multiple pulses is less
pronounced than for the FEL imager since the monitors are further downstream where the beam is wider hence the intensity is lower.

Status: first tunnel installation in preparation.

Figure 6. Scintillation screen tiles for the different Pop-In monitors.

2.6 Exit-slit imager

The grating monochromator in the SASE3 beamline of the European XFEL facility delivers monochromatic radiation to the soft-X-ray experiments SQS and SCS. Placing an imaging system at the exit slit of this monochromator, allows to determine the spectral properties of the FEL, in particular also to measure single-pulse spectra. The design phase has started.

3. INITIAL RESULTS

3.1 Mechanical tests of positioning and repeatability

All 14 Pop-In monitors have been manufactured and delivered. A delicate parameter is the position repeatability of the scintillator and its mechanics if it is moved in and out its recording position. The position repeatability needs to be smaller than the spatial resolution in order to allow using reference images for image calibration and correction. Measurements have been done on a type II-45 Pop-In, see Figure 7. The initial results are summarized in Table 1: the repeatability is smaller than 10 µm which is sufficient for the Pop-In monitors. The high resolution FEL imager has to be tested more carefully.

Table 1. Position repeatability from measurements shown in Figure 7.

<table>
<thead>
<tr>
<th>Shift Δ in motor movement</th>
<th>Shift Δ lateral to motor movement</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Repeatability</td>
</tr>
<tr>
<td>(pixels)</td>
<td>(µm)</td>
</tr>
<tr>
<td>2/3 of full range</td>
<td>0.10</td>
</tr>
<tr>
<td>2/3 of full range</td>
<td>&lt; 0.01</td>
</tr>
<tr>
<td>Full range</td>
<td>&lt; 0.01</td>
</tr>
</tbody>
</table>

3.2 Vacuum tests

All imagers need to respect the UHV vacuum requirements of the European XFEL. Figure 8 shows a measurement of a Pop-In type III together with the essential requirement specifications. All imagers passed these requirements.
Figure 7. Measurement of position repeatability, Pop-In type II-45 (a) In-positions of scintillator holder, (b) subtraction of 2 images from 2 positions, (c) zoom of (b), cross section with line averaging, (d) 3d model of scintillator holder.

Figure 8. Residual gas analysis of Pop-In monitor, type III, measurements by the supplier JJ X-Ray.
3.3 Optical tests of the imaging system

Prototypes have been tested at Synchrotron facilities. Final devices testing starts now. To assure alignment and uniform quality for all devices, first, optical resolution tests will be performed on all devices, followed by selected sample tests under x-rays. An example for tests of spatial resolution of the optical system with optical light is shown in Figure 9. Magnification, working distances and spatial resolution are recorded in this way. A final test document will be provided with each imager.

Figure 9. Pop-In monitors type II-45, test of Kowa objective LM25SC, x14.1 with Basler camera avA1900-50gm, measuring the signal response to an optical test pattern, working distance 337 mm.

4. OPTIMISATION OF COMPONENTS

In parallel to the effort of designing, fabricating and installing devices for the European XFEL, future upgrades are considered and tests are progressing.

4.1 YAG scintillators for visible alignment lasers

For the experimental stations at the European XFEL, commissioning requires precise positioning of components. A laser tracking system referencing position w.r.t. to fiducials is available. Furthermore the components need to be fine positioned w.r.t. the x-ray beam. A visible alignment laser collinear to the x-ray beam helps for this task, in particular within the limited distances at the experimental hutches. To avoid additional monitors for the alignment laser it was investigated if the x-ray monitors with YAG:Ce scintillators could be used. Figure 10 shows the measurements and the fluorescence from a blue laser diode. Emission and excitation spectra for YAG:Ce can be found in the article by Y. Pan.

Blue laser diode spots can be visualised with diagnostic Pop-In monitors under typical conditions, i.e. with a Kowa lens, Basler camera, at typical magnification and working distances. A 1 mW, 405 nm blue laser diode was used. Similar to x-rays the blue laser diode creates fluorescence in the YAG:Ce screen. The signal amplitude is sufficient, even saturating the CCD camera at full aperture of the lens.

4.2 Boron nitride (BN) scintillators for intense FEL radiation

BN is known for its scintillation and has been studied for radiation hardness. It has particular interesting properties in its pyrolytic form that allows an economic fabrication of large and thin sizes of screens: low atomic number, melting point 3000 °C but low heat conductivity of 2 W/(m×K).

Samples of 25×25×0.1 mm³ from CVT, Halblech, Germany, have been tested at the ESRF, ID06 and blue fluorescence has been measured with a photodiode. The x-ray beam characteristics are: energy 12.2 keV, 5×10¹⁰ photons/s, beam size 0.24×0.06 mm². The results are summarised in Table 2. The absolute conversion efficiency of YAG:Ce is between 5-8%. These are first results; they are corrected for the emission characteristics of the screens, but not for all background signals. The deposited dose approximately was: 10⁶ Gy in YAG, and 10⁵ Gy in BN and diamond. No degradation of the materials or their scintillation properties was observed. Whether BN is an appropriate scintillator material depends on radiation hardness, decay time, and long term stability that need more investigation.
Figure 10. Laser spots on white office paper (left) and on the YAG:Ce screen (right). Spot diameter is around 4 mm and 1 mm for the red and the blue laser, respectively. Some reflections from the red laser diode on the YAG are from dust.

Figure 11. BN and YAG:Ce scintillators at 12.2 keV, 5x10^10 ph/s excitation tested at ESRF, ID06. BN is a pyrolytic ceramic with a blue emission, YAG a single crystal polished screen, green emission. Both are 100 μm thick.

Table 2. Energy conversion efficiency of scintillating screens shown in Figure 11 at 12.2 keV.

<table>
<thead>
<tr>
<th>Scintillator</th>
<th>Manufacturer</th>
<th>Rel. energy conversion efficiency c.f. YAG:Ce</th>
</tr>
</thead>
<tbody>
<tr>
<td>YAG:Ce</td>
<td>Crytur</td>
<td>1</td>
</tr>
<tr>
<td>Diamond</td>
<td>Diamond Materials</td>
<td>1.3x10^{-3}</td>
</tr>
<tr>
<td>BN</td>
<td>CVT</td>
<td>2.1x10^{-4}</td>
</tr>
</tbody>
</table>

4.3 Gated and high speed cameras for single FEL pulse recording

All optical cameras foreseen for the first installation of the diagnostic imagers described in this manuscript are slow scan cameras (up to 50 Hz) that cannot resolve single XFEL pulses at 4.5 MHz. Gated slow cameras or high speed cameras are a solution and are studied for future upgrades.

Slow scan cameras can be gated with a fast shutter (image intensifier, MCP) that let one pulse pass. By using interline CCD’s also 2 pulses with μs separation can be recorded.

High speed cameras record 100 - 200 images on the chip. Recording is then interrupted by a readout cycle. Two concepts are particularly interesting: the RAL technology with a pixel structure of CCD memory in CMOS marketed as Kirana by Specialised Imaging and the Hypervision HPV-X CMOS camera by Shimadzu.
Coupled to high aperture and high resolution lenses like for the diagnostic SR imager, it is expected to achieve a noise
equivalent signal NES of approximately 20 keV rms (with YAG:Ce) and a spatial resolution of 30 μm fwhm for a 1
Mpixel image.

5. SUMMARY

X-ray diagnostic imaging stations for the European XFEL facility have been designed; testing and installation starts. The
program is in-line with the facility installation planning for the next 2 years. In parallel, upgrade options are pursued for
different topics: identifying and integrating components, especially scintillators with high resistance against thermal
damage by single or multiple x-ray pulses, and secondly high speed image recording of single XFEL pulses.

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Wrona. The sub-contractor JJ X-Ray, Denmark efficiently collaborated with the European XFEL facility and delivered
all Pop-In monitors.

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